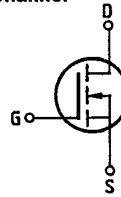


SIEMENS AKTIENGESELLSCHAFT

Main ratings

Drain-source voltage  $V_{DS} = 100\text{ V}$   
 Continuous drain current  $I_D = 18\text{ A}$   
 Drain-source on-resistance  $R_{DS(on)} = 0,1\ \Omega$

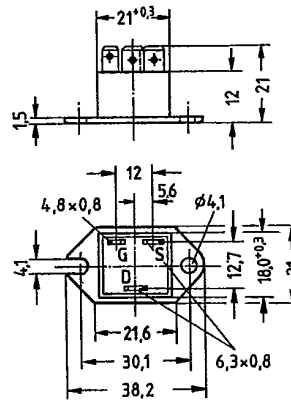
N-Channel



**Description** SIPMOS, N-channel, enhancement mode  
**Case** Plastic package TO 238 AA with insulated metal base plate in accordance with JEDEC, compatible with TO 3; AMP plug-in connections.  
 Approx. weight 21 g

Type	Ordering code
BUZ 28	C67078-A1608-A2

Not for new design



Dimensions in mm

Maximum ratings

Description	Symbols	Ratings	Units	Conditions
Drain-source voltage	$V_{DS}$	100	V	
Drain-gate voltage	$V_{DGR}$	100	V	$R_{GS} = 20\text{ k}\Omega$
Continuous drain current	$I_D$	18	A	$T_C = 35\text{ }^\circ\text{C}$
Pulsed drain current	$I_{D(puls)}$	70	A	$T_C = 25\text{ }^\circ\text{C}$
Gate-source voltage	$V_{GS}$	$\pm 20$	V	
Max. power dissipation	$P_D$	70	W	$T_C = 25\text{ }^\circ\text{C}$
Operating and storage temperature range	$T_j$	$-40 \dots +150$	$^\circ\text{C}$	
Isolation test voltage	$V_{is}$	3500	Vdc <sup>1)</sup>	$t = 1\text{ min}$
DIN humidity category		F	-	DIN 40040
IEC climatic category		40/150/56	-	DIN IEC 68-1

Thermal resistance

Chip - case	$R_{th,JC}$	$\leq 1,78$	K/W
-------------	-------------	-------------	-----

<sup>1)</sup> Isolation test voltage between drain and base plate referred to standard climate 23/50 in accordance with DIN 50014.

## SIEMENS AKTIENGESELLSCHAFT

## Electrical characteristics

(at  $T_j = 25^\circ\text{C}$  unless otherwise specified)

Description	Symbol	Characteristics			Unit	Conditions
		min.	typ.	max.		

## Static ratings

Drain-source breakdown voltage	$V_{(BR)DSS}$	100	—	—	V	$V_{GS} = 0V$ $I_D = 0,25mA$
Gate threshold voltage	$V_{GS(th)}$	2,1	3,0	4,0		$V_{DS} = V_{GS}$ $I_D = 1mA$
Zero gate voltage drain current	$I_{DSS}$	—	20 100	250 1000	$\mu A$	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$ $V_{DS} = 100V$ $V_{GS} = 0V$
Gate-source leakage current	$I_{GSS}$	—	10	100	nA	$V_{GS} = 20V$ $V_{DS} = 0V$
Drain-source on-resistance	$R_{DS(on)}$	—	0,09	0,1	$\Omega$	$V_{GS} = 10V$ $I_D = 9A$

## Dynamic ratings

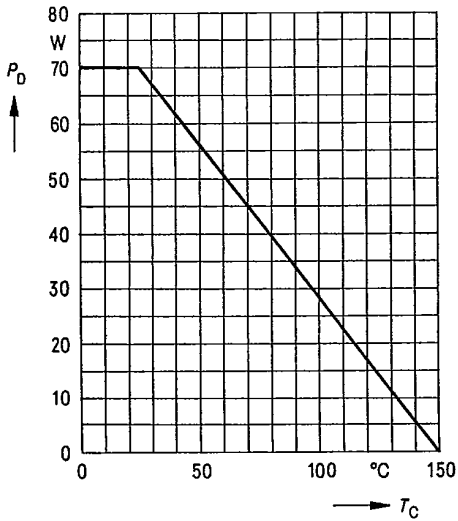
Forward transconductance	$g_{fs}$	4,0	8,0	—	S	$V_{DS} = 25V$ $I_D = 9A$
Input capacitance	$C_{iss}$	—	1500	2000	pF	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1MHz$
Output capacitance	$C_{oss}$	—	450	700		
Reverse transfer capacitance	$C_{rss}$	—	150	240		
Turn-on time $t_{on}$ ( $t_{on} = t_{d(on)} + t_r$ )	$t_{d(on)}$	—	30	45	ns	$V_{CC} = 30V$ $I_D = 3A$ $V_{GS} = 10V$ $R_{GS} = 50\Omega$
	$t_r$	—	50	75		
Turn-off time $t_{off}$ ( $t_{off} = t_{d(off)} + t_f$ )	$t_{d(off)}$	—	170	220		
	$t_f$	—	80	110		

## Reverse diode

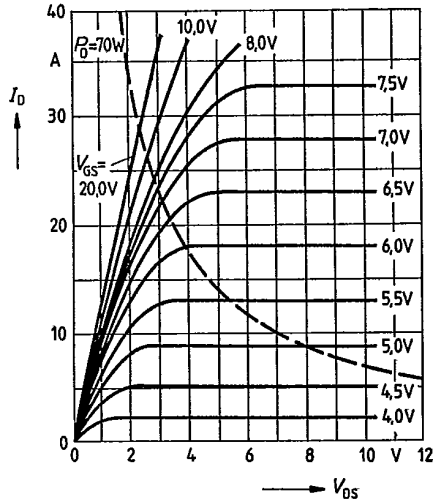
Continuous reverse drain current	$I_{DR}$	—	—	18	A	$T_C = 25^\circ\text{C}$
Pulsed reverse drain current	$I_{DRM}$	—	—	70		
Diode forward on-voltage	$V_{SD}$	—	1,4	2,0	V	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V, T_j = 25^\circ\text{C}$
Reverse recovery time	$t_{rr}$	—	200	—	ns	$T_j = 25^\circ\text{C}$
Reverse recovery charge	$Q_{rr}$	—	0,25	—	$\mu C$	$I_F = I_{DR}$ $d_{F/dt} = 100A/\mu s$ $V_R = 30V$

SIEMENS AKTIENGESELLSCHAFT

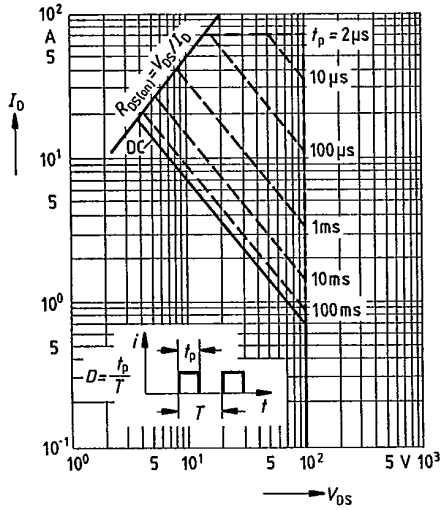
Power dissipation  $P_D = f(T_C)$



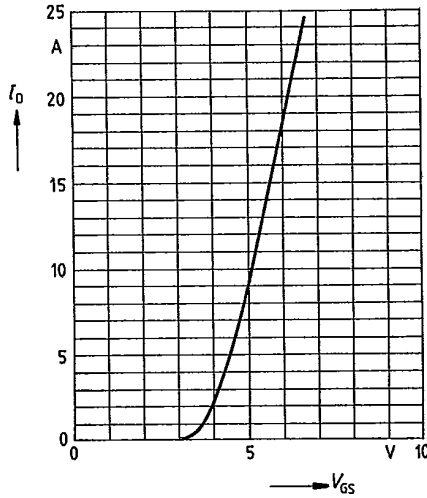
Typical output characteristics  $I_D = f(V_{DS})$   
parameter: 80  $\mu$ s pulse test,  
 $T_J = 25^\circ\text{C}$



Safe operating area  $I_D = f(V_{DS})$   
parameter:  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$



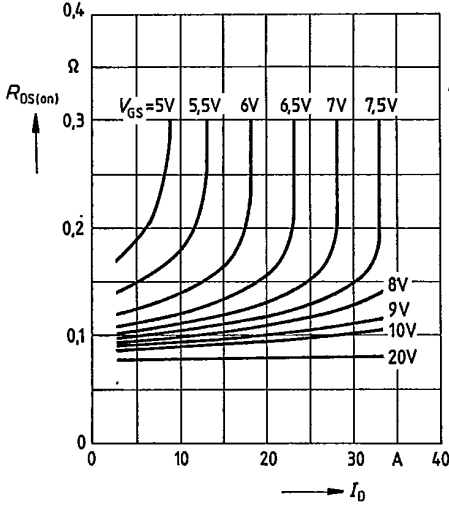
Typical transfer characteristic  $I_D = f(V_{GS})$   
parameter: 80  $\mu$ s pulse test,  
 $V_{DS} = 25\text{V}$ ,  $T_J = 25^\circ\text{C}$



SIEMENS AKTIENGESELLSCHAFT

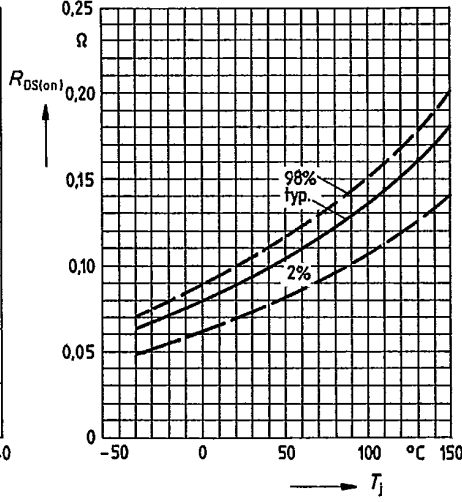
Typical drain-source on-state resistance

$R_{DS(on)} = f(I_D)$   
 parameter:  $V_{GS} = 10V$ ,  $T_j = 25^\circ C$



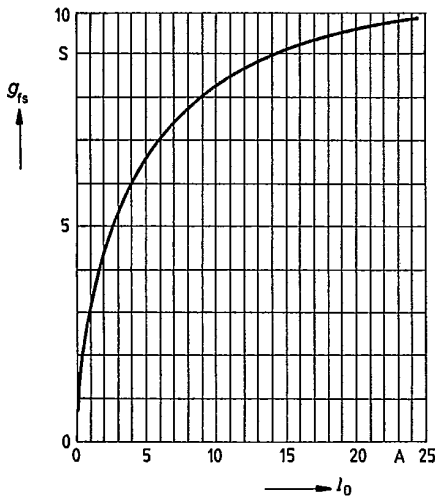
Drain-source on-state resistance

$R_{DS(on)} = f(T_j)$   
 parameter:  $I_D = 9A$ ,  $V_{GS} = 10V$   
 (spread)



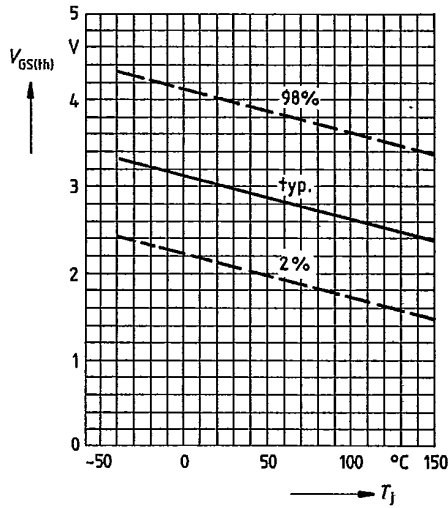
Typical transconductance  $g_{fs} = f(I_D)$

parameter: 80  $\mu s$  pulse test,  
 $V_{DS} = 25V$ ,  $T_j = 25^\circ C$

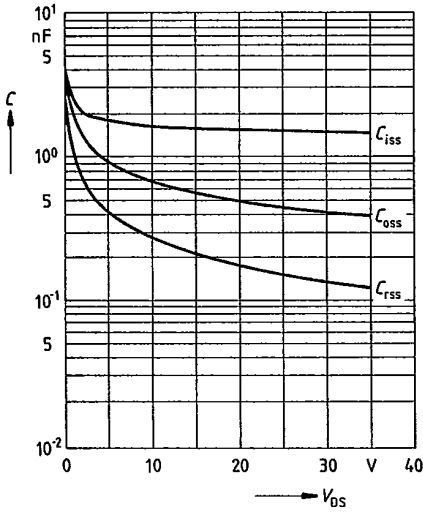


Gate threshold voltage  $V_{GS(th)} = f(T_j)$

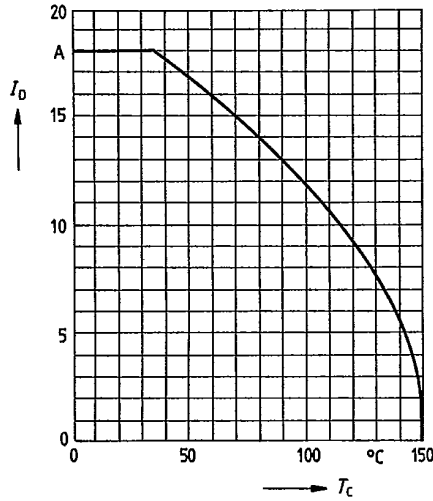
parameter:  $V_{DS} = V_{GS}$ ,  $I_D = 1mA$   
 (spread)



Typical capacitances  $C = f(V_{DS})$   
parameter:  $V_{GS} = 0, f = 1\text{MHz}$

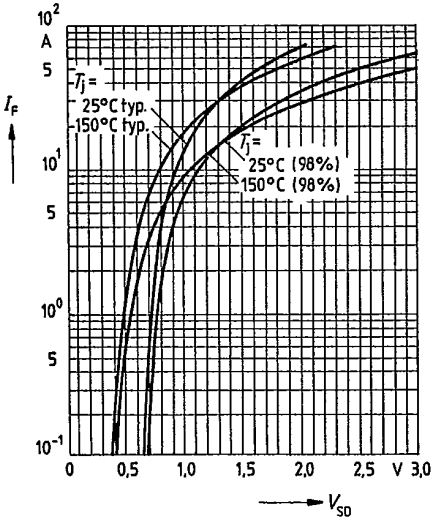


Continuous drain current  $I_D = f(T_C)$   
parameter:  $V_{GS} \geq 10\text{V}$

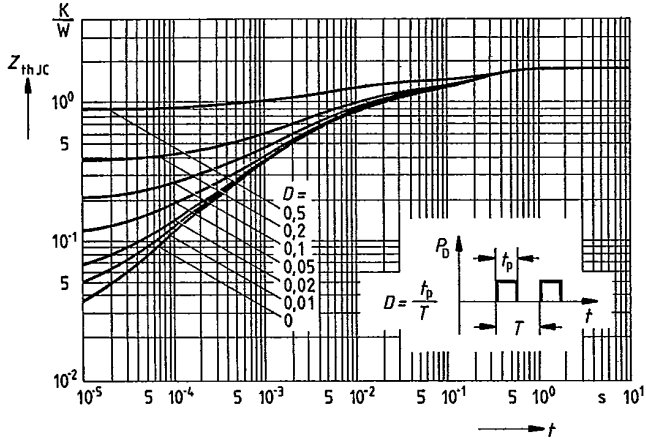


Forward characteristic of reverse diode

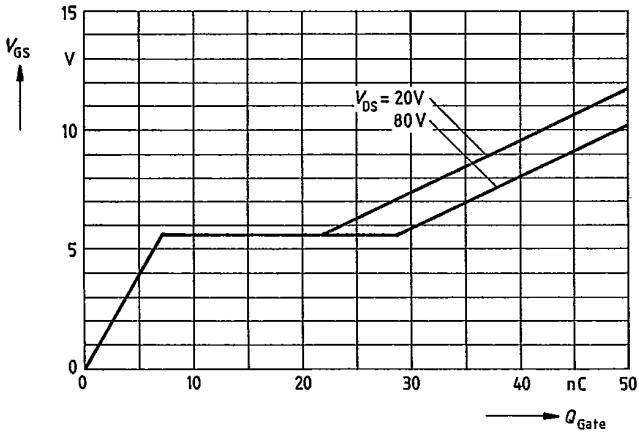
$I_F = f(V_{SD})$   
parameter:  $T_j, t_p = 80 \mu\text{s}$   
(spread)



Transient thermal impedance  $Z_{thJC} = f(t)$   
 parameter:  $D = t_p / T$



Typical gate-charge  $V_{GS} = f(Q_{Gate})$   
 parameter:  $I_{D\ puls} = 28,5A$





LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

[LittleDiode.com](http://LittleDiode.com)

Looking forward to providing you with the best possible service.